

Final Product/Process Change Notification Document # : FPCN20401XA

Issue Date: 6 July 2015

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|--|---|---------------------|----------------|--|
| Title of Change: | Qualification of ON Semiconductor Vietnam (OSV) for Assembly and Test of Zener bidirectional in SMB package | | | |
| Proposed first ship date: | 13 October 2015 or Earlier upon customer approval | | | |
| Contact information: | Contact your local ON Semiconductor Sales Office or <syahrul.samsuddina.rahim@onsemi.com></syahrul.samsuddina.rahim@onsemi.com> | | | |
| Samples: | Contact your local ON Semiconductor Sales Office | | | |
| Additional Reliability Data: | Contact your local ON Semiconductor Sales Office or <cheanching.sim@onsemi.com>.</cheanching.sim@onsemi.com> | | | |
| Type of notification: | This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior | | | |
| | to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com> | | | |
| Change Part Identification: | Devices sourced from ON Semiconductor Vietnam (OSV) will carry the site code "VN" at the bottom of the package | | | |
| Change category: | 🗌 Wafer Fab Change 🛛 Assembly Change 🖾 Test Change 🗌 Other | | | |
| Change Sub-Category(s): | | | | |
| Sites Affected: ON Semiconductor site(s) : | | | | |
| Description and Purpose: This FPCN announces the planned capacity expansion of ON Semiconductor's assembly and test operations of SMB Zener bidirectional products, currently built at ON Semiconductor Malaysia facility to ON Semiconductor Vietnam (OSV). Currently ON Semiconductor Vietnam (OSV) is qualified site for SMB Zener unidirectional products. Upon the expiration of this FPCN, Zener bidirectional products may be processed at either location. These products have been qualified to industrial requirements. These products will continue being Pb-free, Halide free and RoHS compliant. | | | | |
| Reliability Data Summary: | | | | |
| | | | | |
| Test | Conditions | Interval | Result | |
| Autoclave HAST | Ta =121°C, RH=100%, Pressure=15Psig | 96hrs | 0/252 | |
| HTRB | Ta=130°C, 85% RH, Pressure=18.8Psig | 96hrs | 0/252 | |
| HTSL | Ta=150°C, Tj Max=150°C, Tj=150°C Ta=150°C | 1008hrs | 0/252 | |
| IOL | Ta=150 C Ta=25°C, delta Tj=100°C On/off = 2 min | 1008hrs 15000cyc | 0/252 0/252 | |
| RSH | 260°C Immersion | 130000000 | 0/90 | |
| Solderability | Steam Aging=8hrs | 8hrs | 0/45 | |
| тс | Ta=-65/150° C | 1000cyc | 0/252 | |
| | | | | |
| Electrical Characteristic Summary: | | | | |

Electrical characteristics are not impacted



| List of Affected Standard Parts: | | | |
|----------------------------------|--|--|--|
| Qualification Vehicle | | | |
| 1SMB75CAT3G | | | |
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ON Semiconductor



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| P6SMB27CAT3G | 1SMB75CAT3G |
|--------------|-------------|
| P6SMB30CAT3G | 1SMB75CAT3G |
| P6SMB33CAT3G | 1SMB75CAT3G |
| P6SMB36CAT3G | 1SMB75CAT3G |
| P6SMB39CAT3G | 1SMB75CAT3G |
| P6SMB43CAT3G | 1SMB75CAT3G |
| P6SMB47CAT3G | 1SMB75CAT3G |
| P6SMB51CAT3G | 1SMB75CAT3G |
| P6SMB56CAT3G | 1SMB75CAT3G |
| P6SMB62CAT3G | 1SMB75CAT3G |
| P6SMB68CAT3G | 1SMB75CAT3G |
| P6SMB82CAT3G | 1SMB75CAT3G |